

Features

- Supply Voltage: 4.5V to 36V
- Offset Voltage: $\pm 30\mu\text{V}$ Maximum
- Differential Input Voltage Range to Supply Rail, can Work as Comparator
- Input Rail to $-V_s$, Rail to Rail Output
- Drive any capacitive load
- Bandwidth: 6MHz, Slew Rate: $5\text{V}/\mu\text{s}$
- Excellent EMI Suppress Performance: 85dB at 1GHz
- Over-Temperature Protection
- Low Noise: $8\text{ nV}/\sqrt{\text{Hz}}$ at 1kHz
- 2KV HBM, 1KV CDM, 500mA Latch Up
- -40°C to 125°C Operation Temperature Range

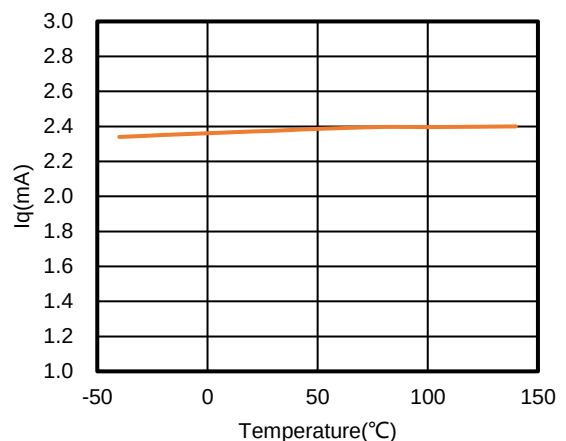
Applications

- Instrumentation
- Active Filters, ASIC Input or Output Amplifier
- Sensor Interface
- Motor Control
- Industrial Control

Description

The TPA186X series amplifiers are newest high supply voltage amplifiers with $15\mu\text{V}$ low offset, low noise and stable high frequency response. They incorporate 3PEAK's proprietary and patented design techniques to achieve very good AC performance with 12MHz bandwidth, $12\text{V}/\mu\text{s}$ slew rate and low distortion while drawing only $2000\mu\text{A}$ of quiescent current per amplifier. The input common-mode voltage range extends to V_- , and the outputs swing rail-to-rail.

The TPA186X has over-temperature protection feature to guarantee the chip safe. The output of TPA186X will enter high impedance when die temperature reach around 170°C and will recover the function when the die temperature down to around 150°C . The product has very small temperature coefficient of power which is helpful for temperature sensitive application.



Pin Configuration

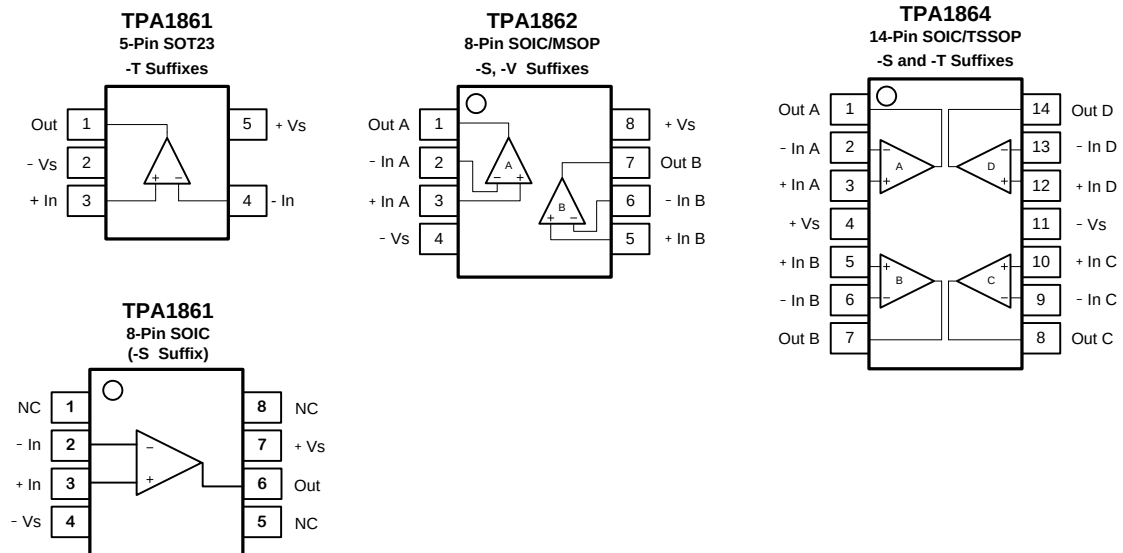


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Revision History

Date	Revision	Notes
2019/1/10	Rev.Pre	Pre-Release Version
2019/9/10	Rev.0	Initial Version
2019/11/27	Rev.0.01	Remove Part Number: TPA1862-TSR, Add Part Number: TPA1864-SR, TPA1864-TR
2020/4/26	Rev.A	Add Test Figure
2020/8/1	Rev.A.1	Add More Test Figure
2020/11/6	Rev.A.2	Update Test Figure: Iq vs. temperature, Vout vs. Iout
2021/5/4	Rev.A.3	Add Tape and Reel Information
2021/7/7	Rev.A.4	Update maximum rating: Input voltage: $(-V_S) - 0.3$ to $(+V_S) + 0.3 \rightarrow (-V_S) - 0.3$ to 40 V Differential Input Voltage : $(+V_S) - (-V_S) \rightarrow (-V_S) - (+V_S)$ to $(+V_S) - (-V_S)$

Order Information

Order Number	Operating Temperature Range	Package	Marking Information	MSL	Transport Media, Quantity
TPA1861-SR	-40 to 125°C	8-Pin SOIC	1861	3	Tape and Reel, 4000
TPA1861-TR	-40 to 125°C	5-Pin SOT23	A86	3	Tape and Reel, 3000
TPA1862-SR	-40 to 125°C	8-Pin SOIC	1862	3	Tape and Reel, 4000
TPA1862-VR	-40 to 125°C	8-Pin MSOP	1862	3	Tape and Reel, 3000
TPA1864-SR	-40 to 125°C	14-Pin SOIC	1864	3	Tape and Reel, 2500
TPA1864-TR	-40 to 125°C	14-Pin TSSOP	1864	3	Tape and Reel, 3000

Absolute Maximum Ratings ^{Note 1}

Parameters	Rating
Supply Voltage, (+V _S)– (–V _S)	40 V
Input Voltage	(–V _S) – 0.3 to 40 V
Differential Input Voltage	(–V _S) - (+V _S) to (+V _S) - (–V _S)
Input Current: +I _{IN} , –I _{IN} ^{Note 2}	±10mA
Output Voltage	(–V _S) – 0.3 to (+V _S) + 0.3
Output Short-Circuit Duration ^{Note 3}	Infinite
Maximum Junction Temperature	150°C
Operating Temperature Range	–40 to 125°C
Storage Temperature Range	–65 to 150°C
Lead Temperature (Soldering, 10 sec)	260°C

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

Note 2: The inputs are protected by ESD protection diodes to negative power supply. If the input extends more than 300mV beyond the negative power supply, the input current should be limited to less than 10mA.

Note 3: A heat sink may be required to keep the junction temperature below the absolute maximum. This depends on the power supply voltage and how many amplifiers are shorted. Thermal resistance varies with the amount of PC board metal connected to the package. The specified values are for short traces connected to the leads.

ESD and Latch Up Rating

Symbol	Parameter	Condition	Minimum Level	Unit
HBM	Human Body Model ESD	ANSI/ESDA/JEDEC JS-001	2	kV
CDM	Charged Device Model ESD	ANSI/ESDA/JEDEC JS-002	1	kV
LU	Latch Up	JESD 78, 25°C	500	mA
		JESD 78, 125°C	250	mA

Thermal Information

Package Type	θ _{JA}	θ _{JC}	Unit
5-Pin SOT23	250	81	°C/W
8-Pin SOIC	158	43	°C/W
8-Pin MSOP	210	45	°C/W
14-Pin SOIC	120	36	°C/W
14-Pin TSSOP	180	35	°C/W

Electrical Characteristics

All test condition is $V_S = 30V$, $T_A = 25^\circ C$, $R_L = 10k\Omega$, unless otherwise noted.

Symbol	Parameter	Conditions	T _A	Min	Typ	Max	Unit
Power Supply							
V _S	Supply Voltage Range			4.5		36	V
I _Q	Quiescent Current per Amplifier	V _S = 30V			1.4	1.6	mA
			-40°C to 125°C			1.8	mA
		V _S = 5V			1.2	1.5	mA
			-40°C to 125°C			1.7	mA
PSRR	Power Supply Rejection Ratio	V _S = 4.5V to 36V		125	140		dB
			-40°C to 125°C	120			dB
Input Characteristics							
V _{OS}	Input Offset Voltage	V _S = 30V, V _{CM} = 15V		-30		30	μV
			-40°C to 125°C	-50		50	μV
		V _S = 5V, V _{CM} = 2.5V		-30		30	μV
			-40°C to 125°C	-50		50	μV
V _{OS} TC	Input Offset Voltage Drift		-40°C to 125°C		0.01	0.2	μV/°C
I _B	Input Bias Current				100		pA
			-40°C to 125°C		100		pA
I _{OS}	Input Offset Current				100		pA
I _{IN}	Different Input Current	V _S = 36V, V _{ID} = 36V			10	100	μA
			-40°C to 125°C			120	μA
C _{IN}	Input Capacitance	Differential Mode			5		pF
		Common Mode			2.5		pF
A _v	Open-loop Voltage Gain	R _{LOAD} = 10kΩ, V _{OUT} = 0.5 V to 29.5 V		130	140		dB
			-40°C to 125°C	125			dB
V _{CMR}	Common-mode Input Voltage Range			(V-)		(V+) – 1.5	V
CMRR	Common Mode Rejection Ratio	V _{CM} = 0V to 28.5V		125	140		dB
			-40°C to 125°C	120			dB

Output Characteristics							
	Output Swing from Positive Rail	$R_{LOAD} = 100k\Omega$ to $V_S/2$			10	15	mV
			-40°C to 125°C			30	mV
		$R_{LOAD} = 10k\Omega$ to $V_S/2$			75	100	mV
			-40°C to 125°C			180	mV
		$R_{LOAD} = 2k\Omega$ to $V_S/2$			400	500	mV
			-40°C to 125°C			750	mV
	Output Swing from Negative Rail	$R_{LOAD} = 100k\Omega$ to $V_S/2$			3	5	mV
			-40°C to 125°C			10	mV
		$R_{LOAD} = 10k\Omega$ to $V_S/2$			25	35	mV
			-40°C to 125°C			60	mV
		$R_{LOAD} = 2k\Omega$ to $V_S/2$			130	150	mV
			-40°C to 125°C			300	mV
I_{SC}	Output Short-Circuit Current	Source		60	95		mA
			-40°C to 85°C	40			mA
			-40°C to 125°C	35			mA
		Sink		130	150		mA
			-40°C to 85°C	100			mA
			-40°C to 125°C	85			mA
	Capacitive Load Drive				1		nF
AC Specifications							
GBW	Gain-Bandwidth Product				6		MHz
SR	Slew Rate	$G = 1$, 10V step		3	5		V/ μ s
			-40°C to 125°C	2.2			V/ μ s
t_{OR}	Overload Recovery				500		ns
t_S	Settling Time, 0.1%	$G = 1$, 10V step			7		μ s
	Settling Time, 0.01%				12		μ s
PM	Phase Margin	$R_L=10K$, $C_L=100pF$			70		°
GM	Gain Margin	$R_L=10K$, $C_L=100pF$			15		dB
Noise Performance							
E_N	Input Voltage Noise	$f = 0.1Hz$ to 10Hz			0.1		μV_{pp}
e_N	Input Voltage Noise Density	$f = 0.1Hz$			8		nV/ $\sqrt{Hz}$
		$f = 1kHz$			8		nV/ $\sqrt{Hz}$
		$f = 10kHz$			10		nV/ $\sqrt{Hz}$
		$f = 100kHz$			20		nV/ $\sqrt{Hz}$
i_N	Input Current Noise	$f = 10kHz$			200		fA/ $\sqrt{Hz}$
THD+N	Total Harmonic Distortion and Noise	$f = 1kHz$, $G = 1$, $R_L = 10k\Omega$, $V_{OUT} = 6V_{RMS}$			0.0005		%

Typical Performance Characteristics

$V_S = \pm 15V$, $V_{CM} = 0V$, $R_L = 10k\Omega$, unless otherwise specified.

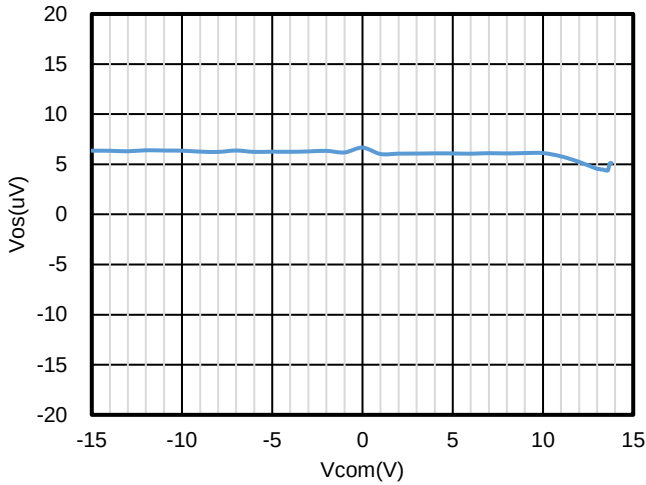


Figure 1. Offset Voltage vs. Common Mode Voltage

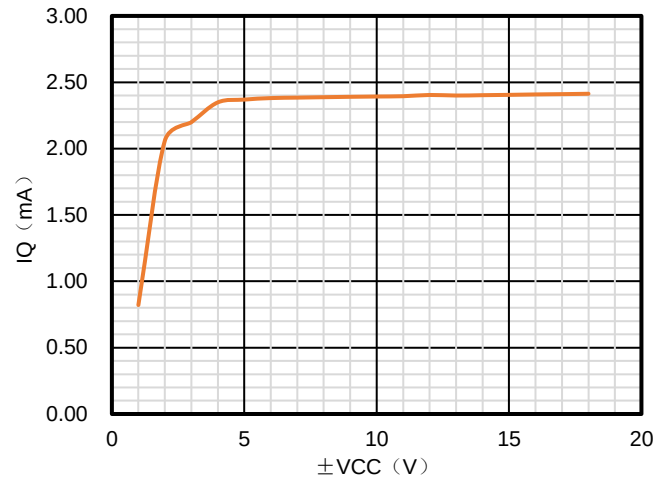


Figure 2. Iq vs. Supply Voltage

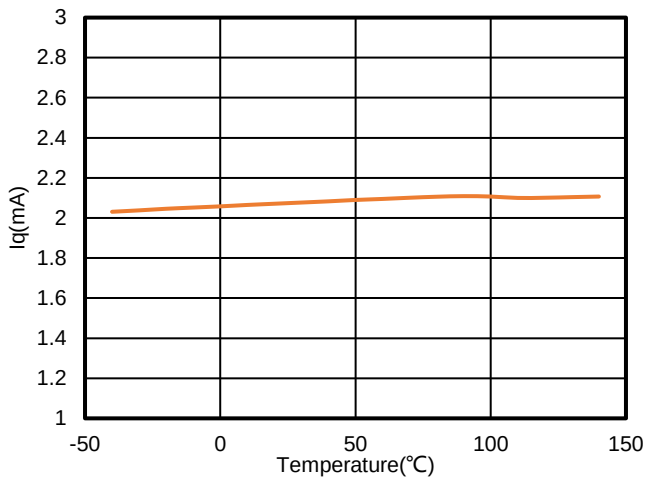


Figure 3. Iq vs. Temperature, +2.5V Supply, TPA1862

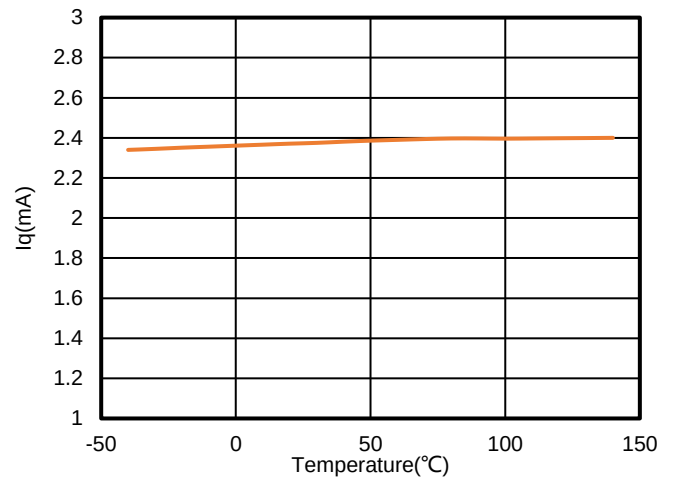


Figure 4. Iq vs. Temperature, +15V Supply, TPA1862

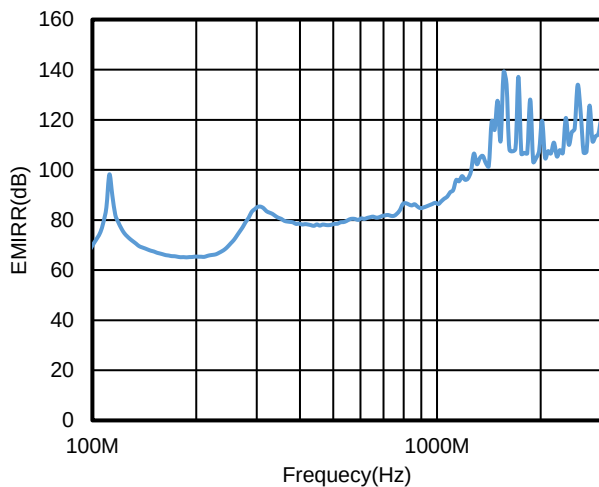


Figure 5. EMIRR vs. Frequency

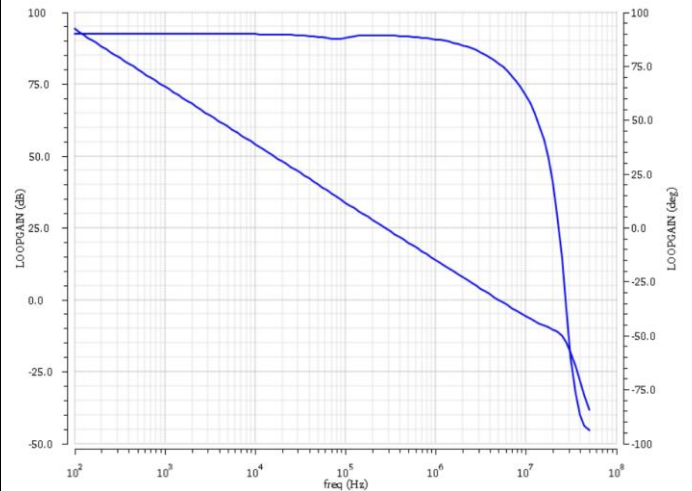
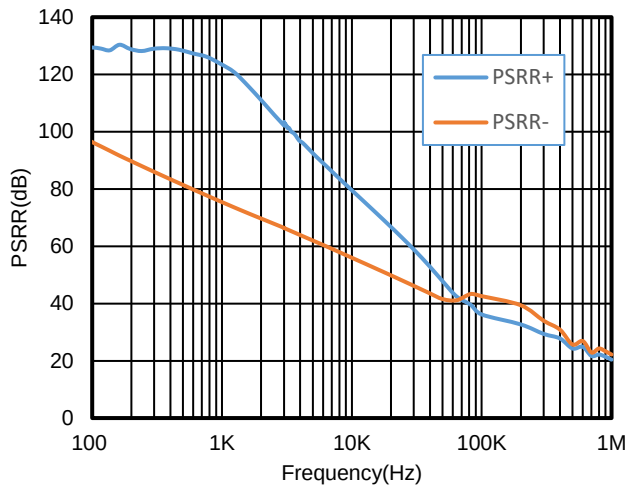
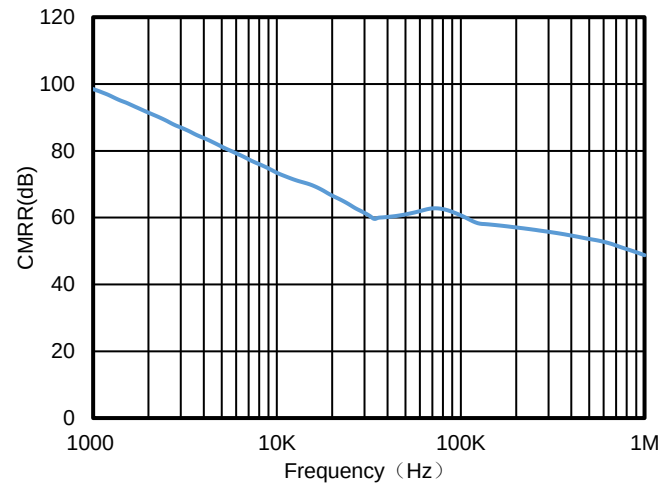
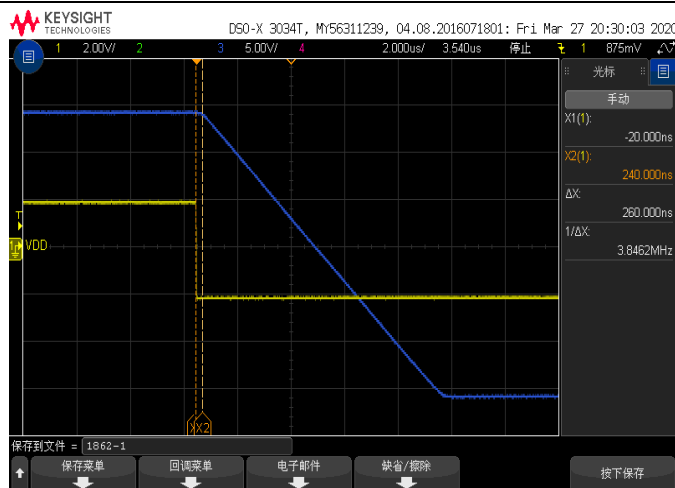
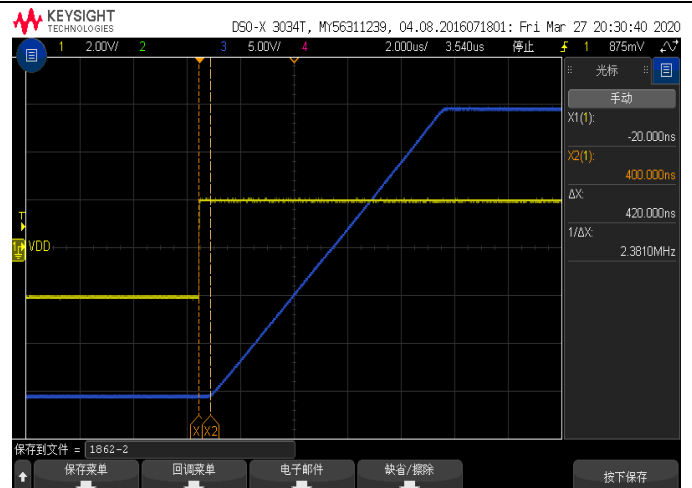


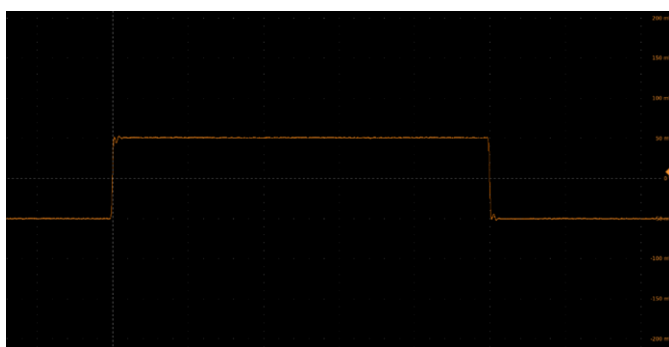
Figure 6. Open Loop Gain and Phase vs. Frequency


Figure 7. PSRR vs. Frequency

Figure 8. CMRR vs. Frequency


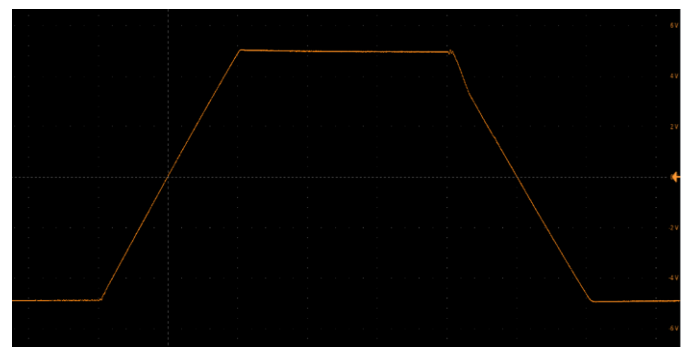
Time: 2us/div, Measure Time: 260ns
 $R_L=2K$, $C_L=100pF$, $G=10$
Figure 9. Positive Overload Recovery



Time: 2us/div, Measure Time: 420ns
 $R_L=2K$, $C_L=100pF$, $G=10$
Figure 10. Negative Overload Recovery



Voltage: 50mV/div, Time: 2us/div
 $R_L=2K$, $C_L=100pF$, $G=1$
Figure 11. 100mV Signal Step Response



Voltage: 2V/div, Time: 2μs/div
 $R_L=2K$, $C_L=100pF$, $G=1$
Figure 12. 10V Signal Step Response

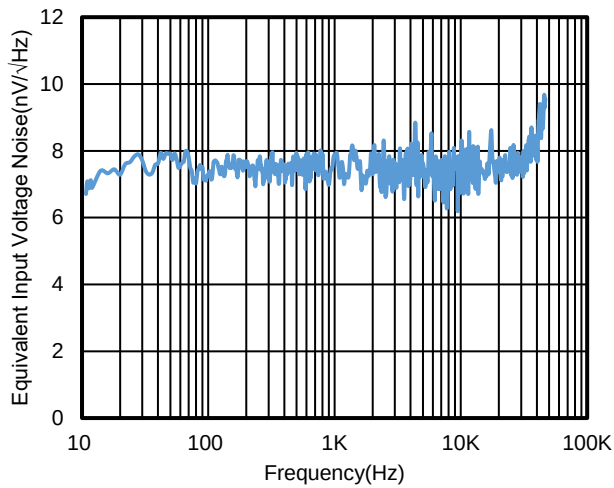


Figure 13. Voltage Noise Density vs. Frequency

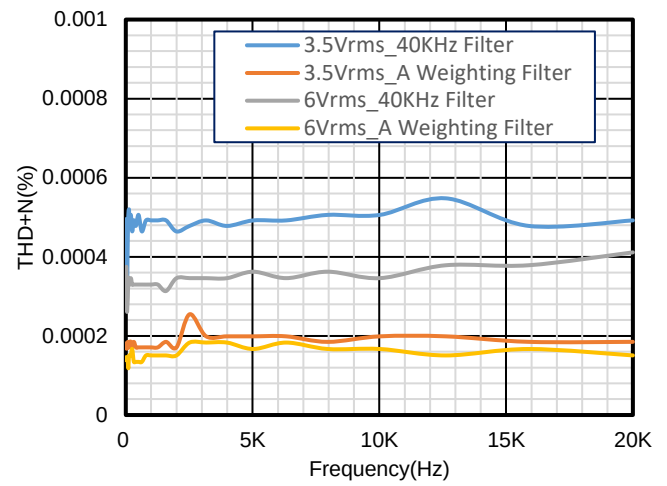


Figure 14. THD+N vs. Frequency, G = 1

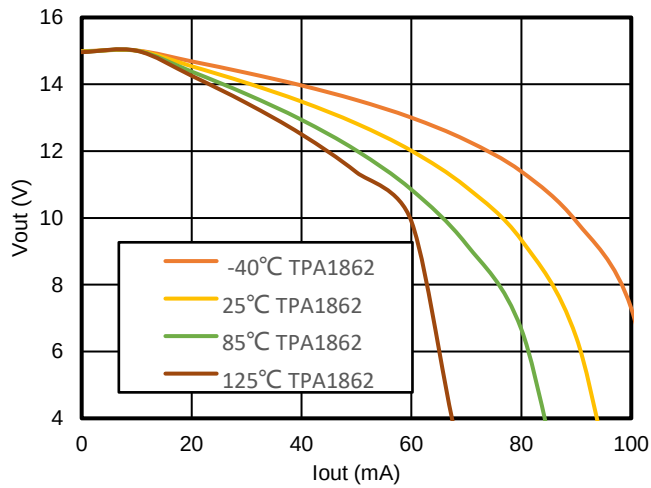


Figure 15. V_{OUT} vs. I_{OUT} , Source

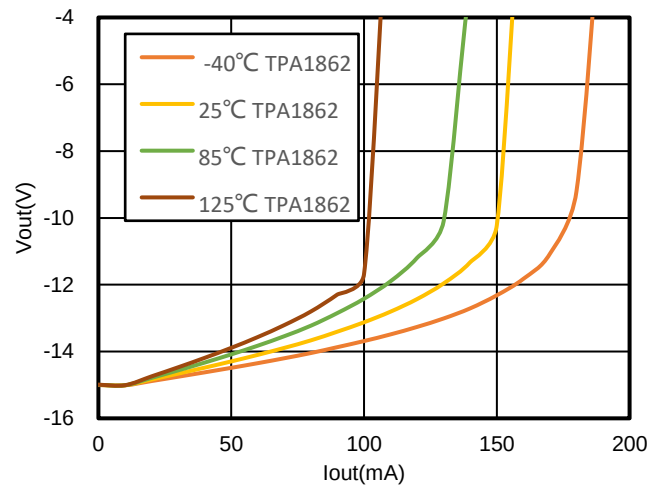
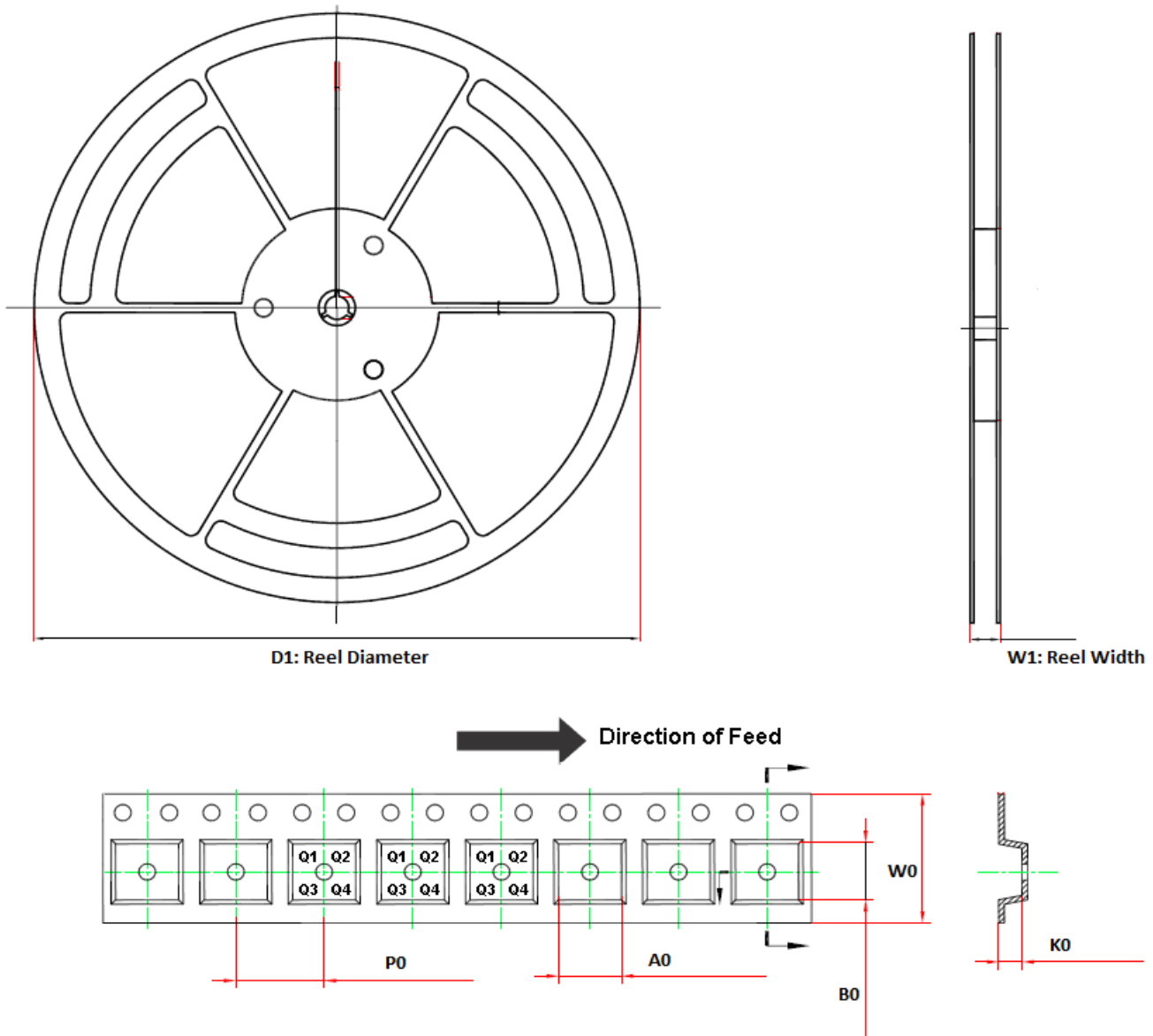


Figure 16. V_{OUT} vs. I_{OUT} , Sink

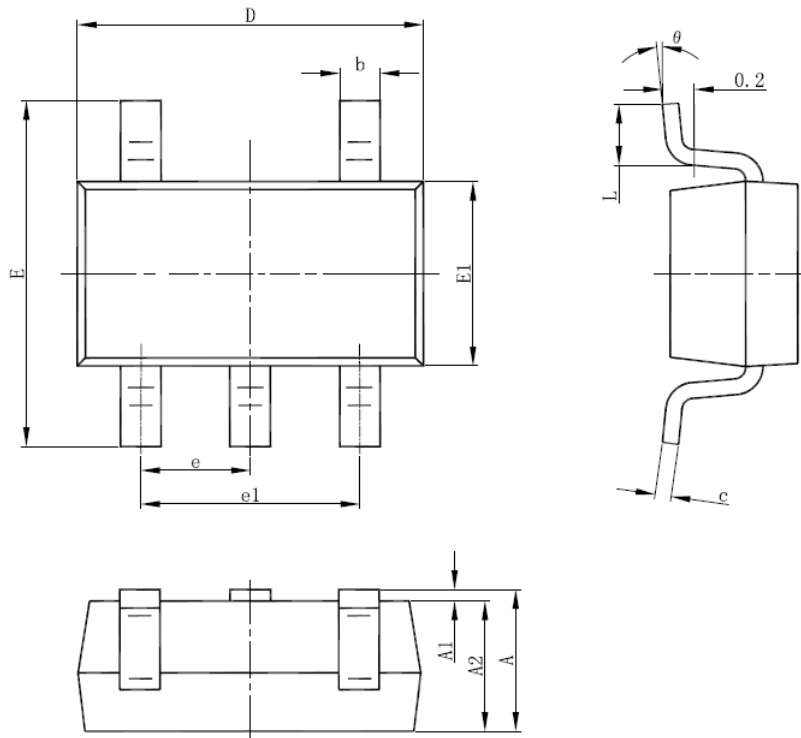
Tape and Reel Information



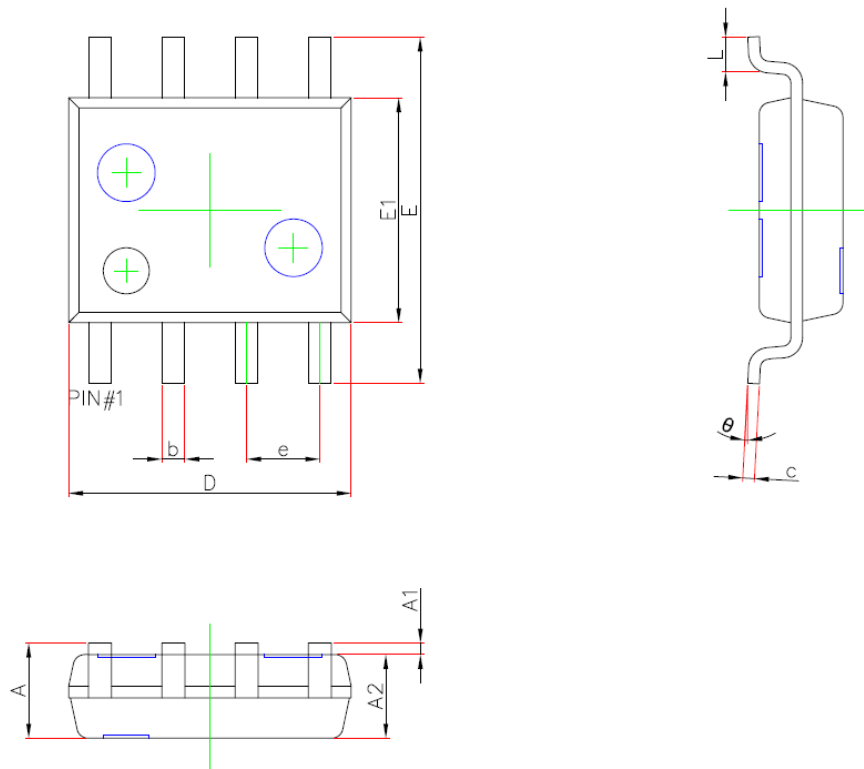
Order Number	Package	D1	W1	A0	B0	K0	P0	W0	Pin1 Quadrant
TPA1861-TR	5-Pin SOT23	180.0	13.1	3.2	3.2	1.4	4.0	8.0	Q3
TPA1861-SR	8-Pin SOIC	330.0	17.6	6.4	5.4	2.1	8.0	12.0	Q1
TPA1862-SR	8-Pin SOIC	330.0	17.6	6.4	5.4	2.1	8.0	12.0	Q1
TPA1862-VR	8-Pin MSOP	330.0	17.6	5.2	3.3	1.5	8.0	12.0	Q1
TPA1864-SR	14-Pin SOIC	330.0	21.6	6.5	9.0	2.1	8.0	16.0	Q1
TPA1864-TR	14-Pin TSSOP	330.0	17.6	6.8	5.4	1.2	8.0	12.0	Q1

Package Outline Dimensions

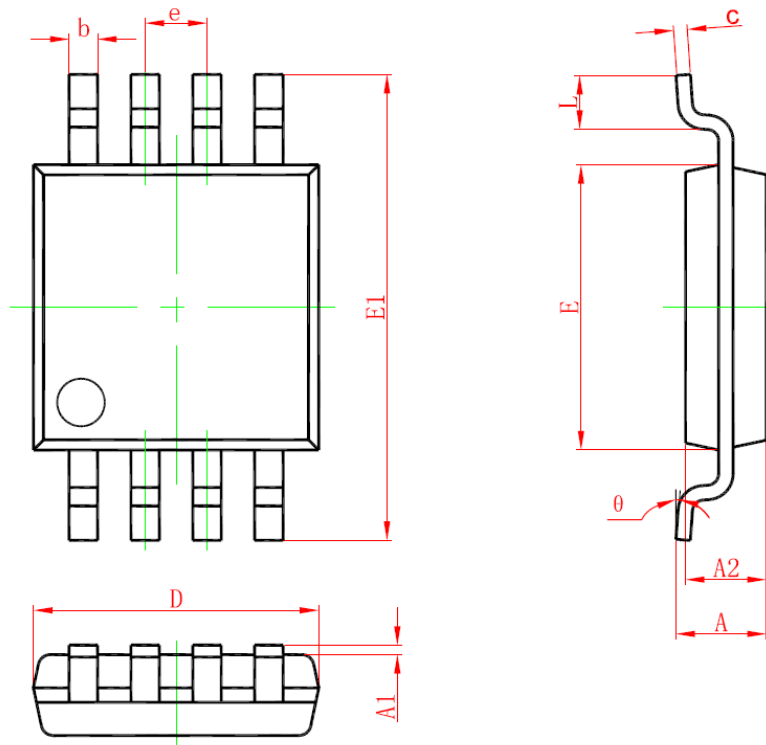
SOT23-5



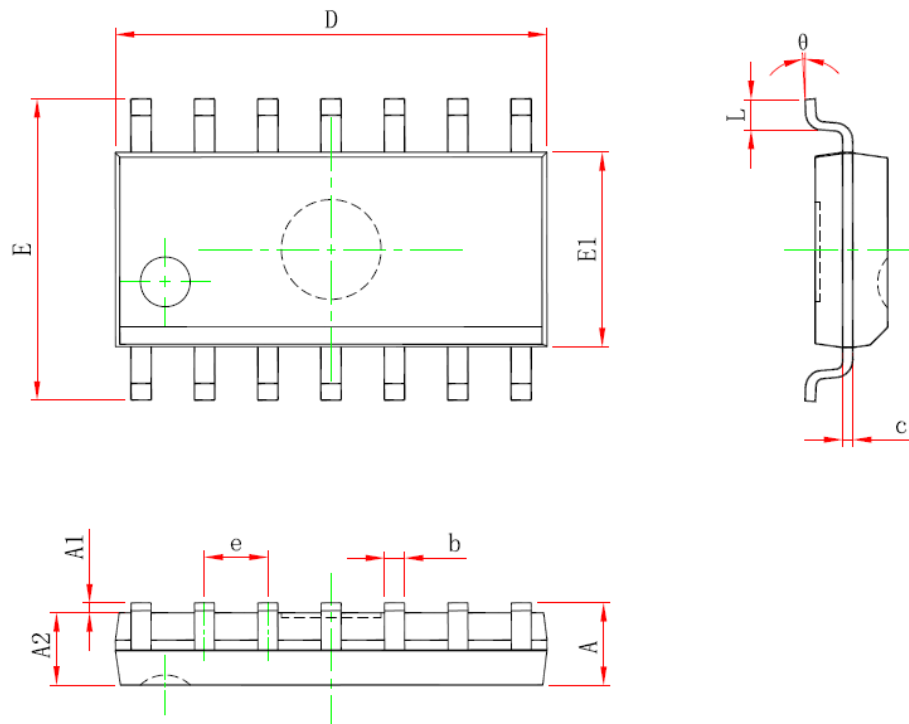
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E1	1.500	1.700	0.059	0.067
E	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

SOIC-8


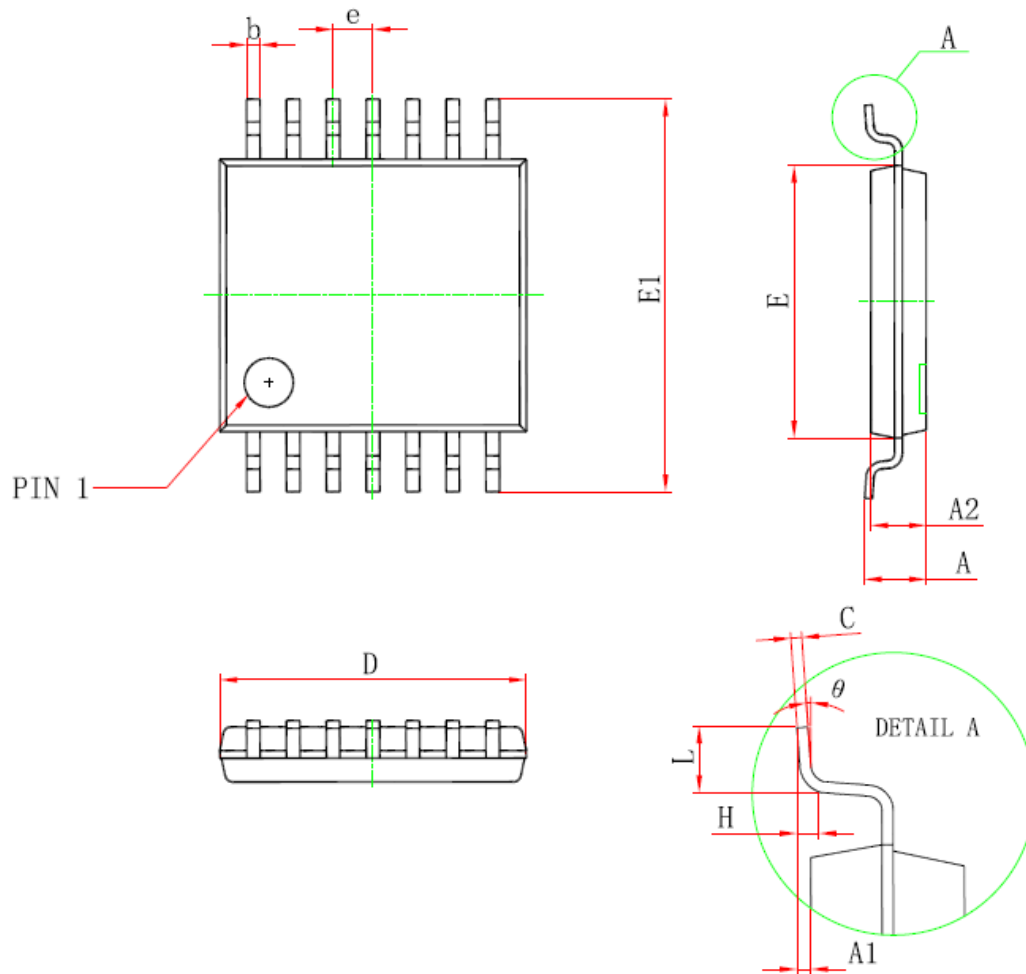
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.007	0.010
D	4.700	5.100	0.185	0.201
E	5.800	6.200	0.228	0.244
E1	3.800	4.000	0.150	0.157
e	1.270(BSC)		0.050(BSC)	
L	0.400	0.800	0.016	0.031
θ	0°	8°	0°	8°

MSOP-8


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.820	1.100	0.032	0.043
A1	0.020	0.150	0.001	0.006
A2	0.750	0.950	0.030	0.037
b	0.250	0.380	0.010	0.015
c	0.090	0.230	0.004	0.009
D	2.900	3.100	0.114	0.122
e	0.650(BSC)		0.026(BSC)	
E	2.900	3.100	0.114	0.122
E1	4.750	5.050	0.187	0.199
L	0.400	0.800	0.016	0.031
θ	0°	6°	0°	6°

SOIC-14


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	—	1.750	—	0.069
A1	0.100	0.250	0.004	0.010
A2	1.250	—	0.049	—
b	0.310	0.510	0.012	0.020
c	0.100	0.250	0.004	0.010
D	8.450	8.850	0.333	0.348
E	5.800	6.200	0.228	0.244
E1	3.800	4.000	0.150	0.157
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

TSSOP-14


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
D	4.900	5.100	0.193	0.201
E	4.300	4.500	0.169	0.177
b	0.190	0.300	0.007	0.012
e	0.090	0.200	0.004	0.008
E1	6.250	6.550	0.246	0.258
A		1.200		0.047
A2	0.800	1.000	0.031	0.039
A1	0.050	0.150	0.002	0.006
e	0.65 (BSC)		0.026 (BSC)	
L	0.500	0.700	0.020	0.028
H	0.25(TYP)		0.01(TYP)	
θ	1°	7°	1°	7°

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